

SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDFS066A – MARCH 1987 – REVISED OCTOBER 1993

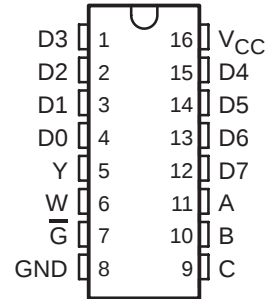
- 3-State Versions of SN54F151B and SN74F151B
- 3-State Outputs Interface Directly With System Bus
- Performs Parallel-to-Serial Conversion
- Complementary Outputs Provide True and Inverted Data
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

description

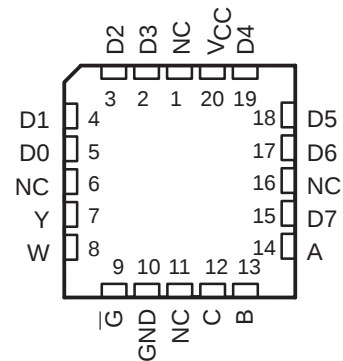
These data selectors/multiplexers contain full binary decoding to select one of eight data sources and feature strobe-controlled complementary outputs. The 3-state outputs can interface with and drive data lines of bus-organized systems. When the strobe ($\overline{G}$) input is high, both outputs are in a high-impedance state in which both the upper and lower transistors of each totem-pole output are off, and the output neither drives nor loads the bus significantly.

The SN54F251B is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74F251B is characterized for operation from 0°C to 70°C .

SN54F251B . . . J PACKAGE
SN74F251B . . . D OR N PACKAGE
(TOP VIEW)



SN54F251B . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

INPUTS				OUTPUTS	
SELECT			STROBE $\overline{G}$	Y	W
C	B	A			
X	X	X	H	Z	Z
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

D0, D1, . . . D7 = the level of the respective D input.

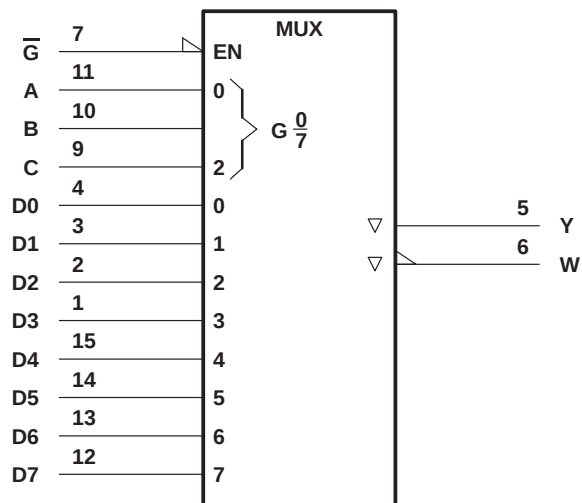
SN54F251B, SN74F251B

1-OF-8 DATA SELECTORS/MULTIPLEXERS

WITH 3-STATE OUTPUTS

SDFS066A – MARCH 1987 – REVISED OCTOBER 1993

logic symbol[†]

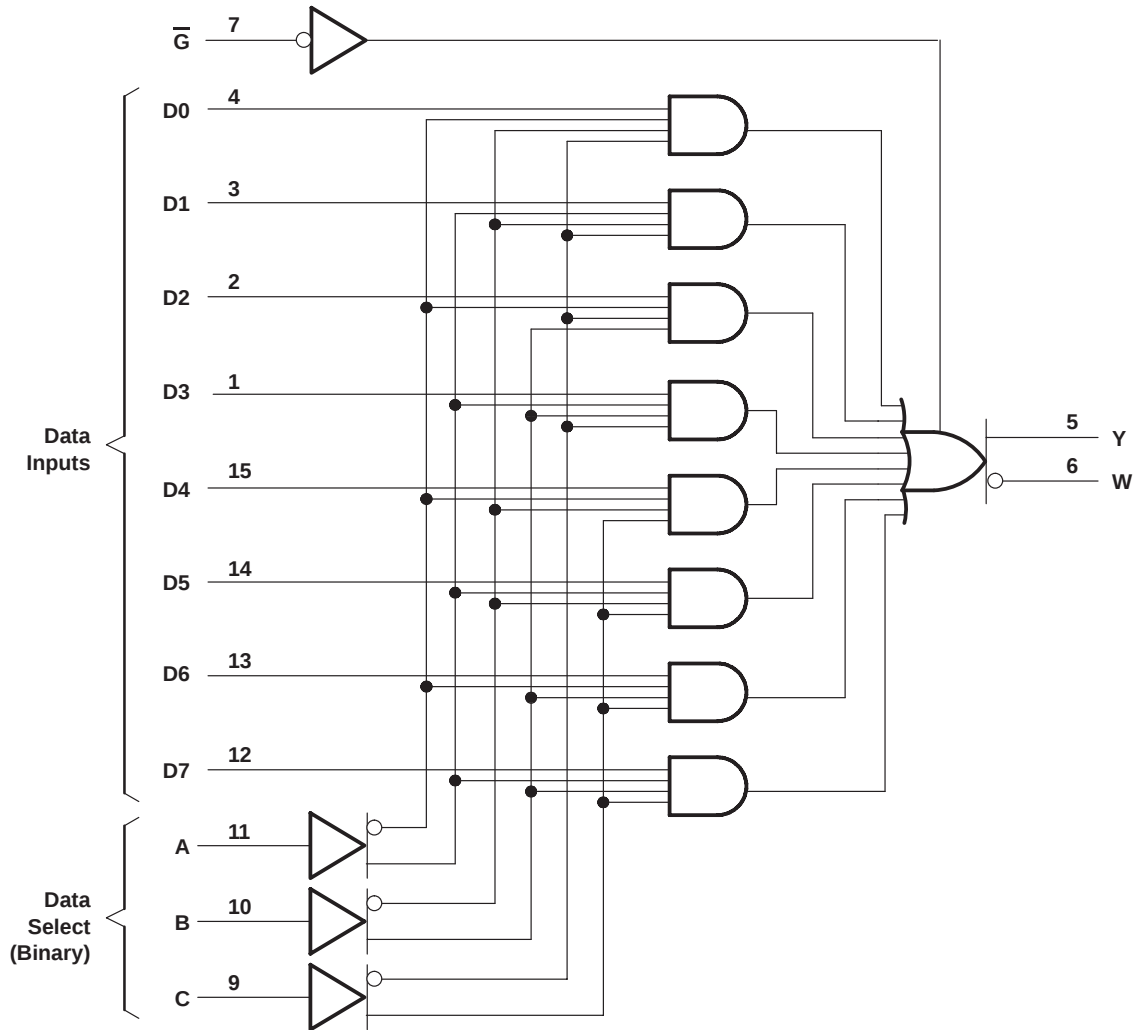


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDFS066A – MARCH 1987 – REVISED OCTOBER 1993

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range (see Note 1)	–1.2 V to 7 V
Input current range	–30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state	–0.5 V to 5.5 V
Voltage range applied to any output in the high state	–0.5 V to V_{CC}
Current into any output in the low state: SN54F251B	40 mA
SN74F251B	48 mA
Operating free-air temperature range: SN54F251B	–55°C to 125°C
SN74F251B	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



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SN54F251B, SN74F251B

1-OF-8 DATA SELECTORS/MULTIPLEXERS

WITH 3-STATE OUTPUTS

SDFS066A – MARCH 1987 – REVISED OCTOBER 1993

recommended operating conditions

		SN54F251B			SN74F251B			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{IK}	Input clamp current			-18			-18	mA
I_{OH}	High-level output current			-3			-3	mA
I_{OL}	Low-level output current			20			24	mA
T_A	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54F251B			SN74F251B			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 4.5\text{ V}$	$I_I = -18\text{ mA}$			-1.2			-1.2	V
V_{OH}	$V_{CC} = 4.5\text{ V}$	$I_{OH} = -1\text{ mA}$	2.5	3.4		2.5	3.4		V
		$I_{OH} = -3\text{ mA}$	2.4	3.3		2.4	3.3		
	$V_{CC} = 4.75\text{ V}$	$I_{OH} = -1\text{ mA to } -3\text{ mA}$				2.7			
V_{OL}	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 20\text{ mA}$	0.3	0.5					V
		$I_{OL} = 24\text{ mA}$				0.35	0.5		
I_{OZH}	$V_{CC} = 5.5\text{ V}$	$V_O = 2.7\text{ V}$			50			50	μA
I_{OZL}	$V_{CC} = 5.5\text{ V}$	$V_O = 0.5\text{ V}$			-50			-50	μA
I_I	$V_{CC} = 5.5\text{ V}$	$V_I = 7\text{ V}$			0.1			0.1	mA
I_{IH}	$V_{CC} = 5.5\text{ V}$	$V_I = 2.7\text{ V}$			20			20	μA
I_{IL}	$V_{CC} = 5.5\text{ V}$	$V_I = 0.5\text{ V}$			-0.6			-0.6	mA
$I_{OS}^\ddagger$	$V_{CC} = 5.5\text{ V}$	$V_O = 0$	-60		-150	-60		-150	mA
I_{CC}	$V_{CC} = 5.5\text{ V}$, See Note 2	Condition A	15	22		15	22		mA
		Condition B	16	24		16	24		

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: I_{CC} is measured with the outputs open under the following conditions:

- A. Select input and data input at 4.5 V, output control grounded
- B. All inputs at 4.5 V

SN54F251B, SN74F251B

1-OF-8 DATA SELECTORS/MULTIPLEXERS

WITH 3-STATE OUTPUTS

SDFS066A – MARCH 1987 – REVISED OCTOBER 1993

switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	VCC = 5 V, CL = 50 pF, R1 = 500 Ω, R2 = 500 Ω, TA = 25°C			VCC = 4.5 V to 5.5 V, CL = 50 pF, R1 = 500 Ω, R2 = 500 Ω, TA = MIN to MAX †				UNIT
			'F251B			SN54F251B		SN74F251B		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
tPLH	A, B, or C	W	3.5	5.4	9	3.5	11.5	3.5	9.5	ns
tPHL			2.5	4.4	7.5	2.5	8	2.5	7.5	
tPLH	A, B, or C	Y	4.5	6.2	10.5	3.5	14	4	12.5	ns
tPHL			4	6	8.5	3	10.9	3.5	9	
tPLH	Any D	W	2.5	3.7	6.5	1.8	8	2	7	ns
tPHL			1	1.9	4	1	6	1	5	
tPLH	Any D	Y	3	3.8	7	2.3	9	2.3	8	ns
tPHL			3	4.5	7	2.3	9	2.5	8	
tPZH	$\overline{G}$	W	2.5	3.6	6	2	7	2	7	ns
tPZL			2.5	3.8	6	2.5	7.5	2.5	6.5	
tPHZ	$\overline{G}$	W	1.9	2.5	5.5	1.4	6	1.5	6	ns
tPLZ			1	2.4	4.5	1	5	1	4.5	
tPZH	$\overline{G}$	Y	3.4	4.8	7	2.7	8.5	2.9	8.5	ns
tPZL			2.9	4	7.5	2.6	9	2.6	8	
tPHZ	$\overline{G}$	Y	1.9	2.5	5.5	1.7	5.5	1.8	5.5	ns
tPLZ			1	2.3	4.5	1	5.5	1	4.5	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 3: Load circuits and waveforms are shown in Section 1.



PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74F251BD	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	0 to 70	F251B
SN74F251BDR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F251B
SN74F251BDR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	F251B
SN74F251BN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F251BN
SN74F251BN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74F251BN

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F251BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F251BDR	SOIC	D	16	2500	353.0	353.0	32.0

TUBE

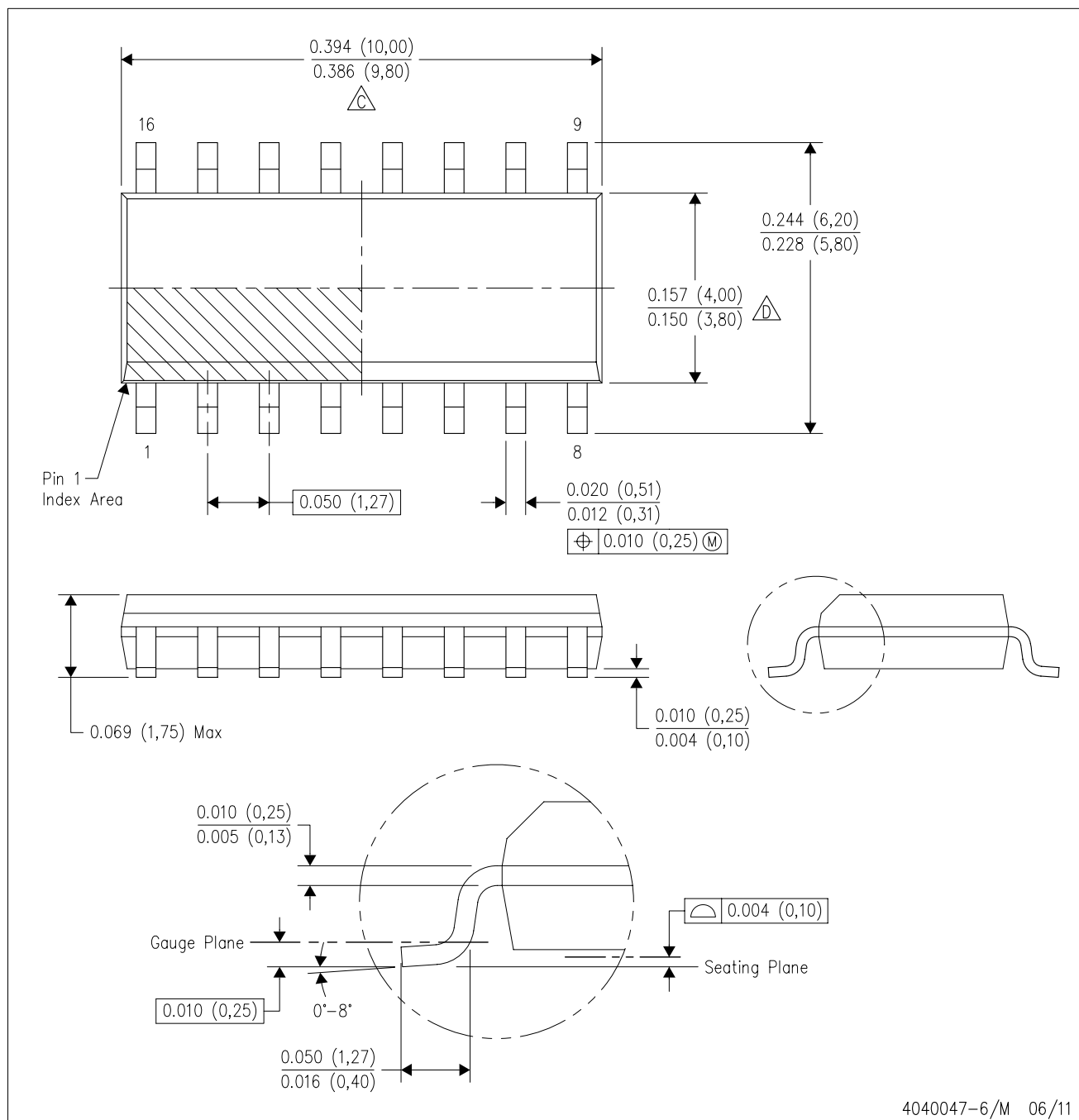


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74F251BN	N	PDIP	16	25	506	13.97	11230	4.32
SN74F251BN	N	PDIP	16	25	506	13.97	11230	4.32
SN74F251BN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74F251BN.A	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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Last updated 10/2025